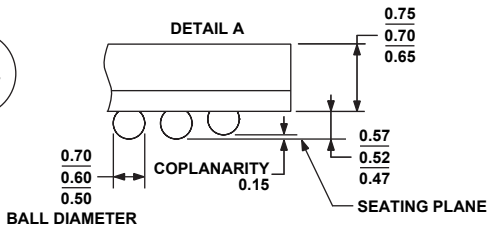
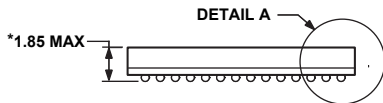
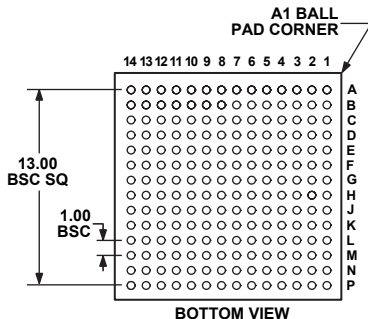
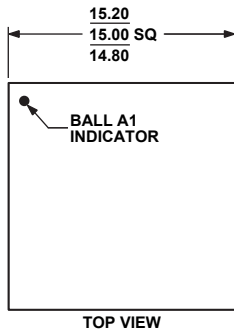


# 196-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]

(BC-196-2)

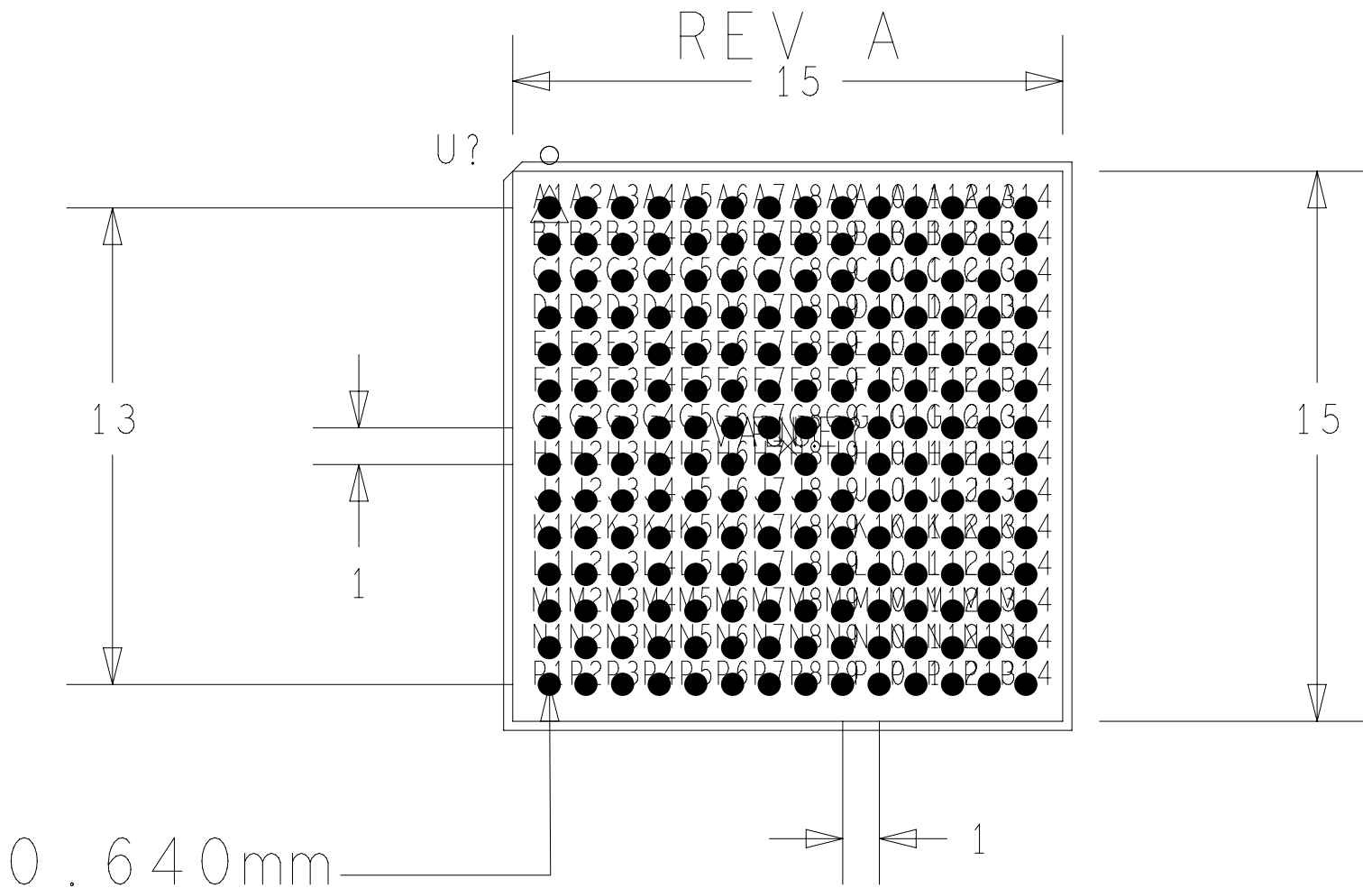
Dimensions shown in millimeters



\*COMPLIANT TO JEDEC STANDARDS MO-192-AAE-1  
WITH THE EXCEPTION TO PACKAGE HEIGHT.

# Analog Devices

BC-196-2



(Dim. are in MM)

LAST MODIFIED 09/11/07